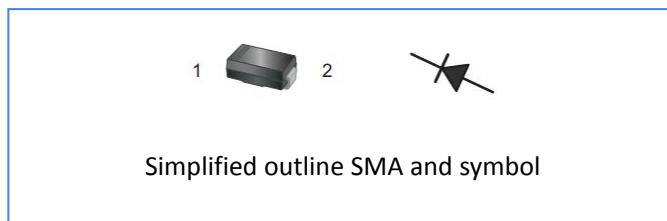


ES1A THRU ES1J

Features

- For surface mounted applications
- Low profile package
- Glass Passivated Chip Junction
- Superfast reverse recovery time
- Lead free in comply with EU RoHS 2011/65/EU directives



Mechanical Data

- Case:SMA
- Terminals: Solderable per MIL-STD-750, Method 2026
- Approx.Weight: 0.055g / 0.002oz

Pinning

PIN	DESCRIPTION
1	Cathode
2	Anode

Absolute Maximum Ratings And Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%.

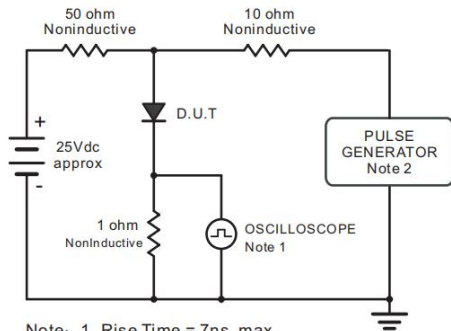
Parameter	Symbols	ES1A	ES1B	ES1C	ES1D	ES1E	ES1G	ES1J	Units
Maximum Repetitive Peak Reverse Voltage	V_{RRM}	50	100	150	200	300	400	600	V
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	420	V
Maximum DC Blocking Voltage	V_{DC}	50	100	150	200	300	400	600	V
Maximum Average Forward Rectified Current	$I_{F(AV)}$	1							A
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	I_{FSM}	30							A
Maximum Forward Voltage at 1 A	V_F	1.0			1.25		1.70		V
Maximum DC Reverse Current $T_a = 25^\circ C$ at Rated DC Blocking Voltage $T_a = 125^\circ C$	I_R	5 100							μA
Typical Junction Capacitance at $V_R=4V, f=1MHz$	C_j	15							pF
Maximum Reverse Recovery Time ⁽¹⁾	t_{rr}	35							ns
Typical Thermal Resistance ⁽²⁾	$R_{\theta JA}$	75							$^\circ C/W$
Operating and Storage Temperature Range	T_j, T_{stg}	-55 ~ +150							$^\circ C$

(1) Measured with $I_F = 0.5 A, I_R = 1 A, I_{rr} = 0.25 A$

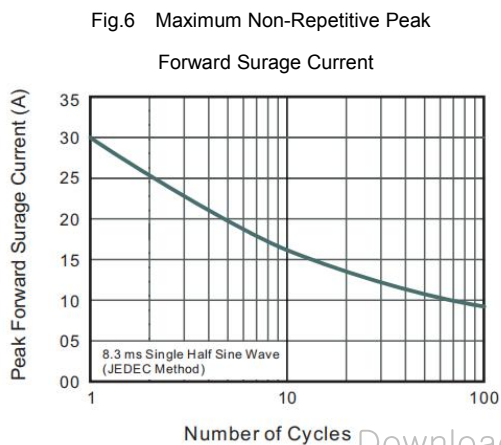
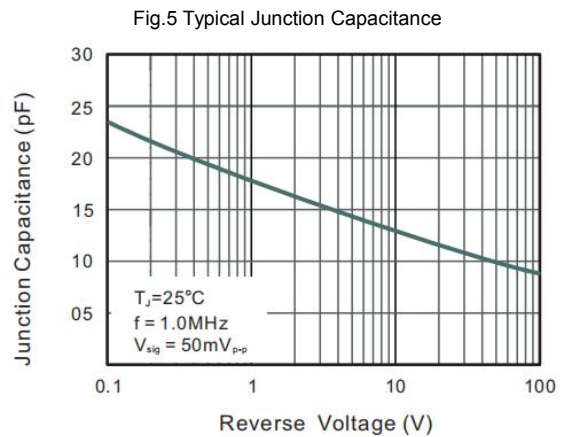
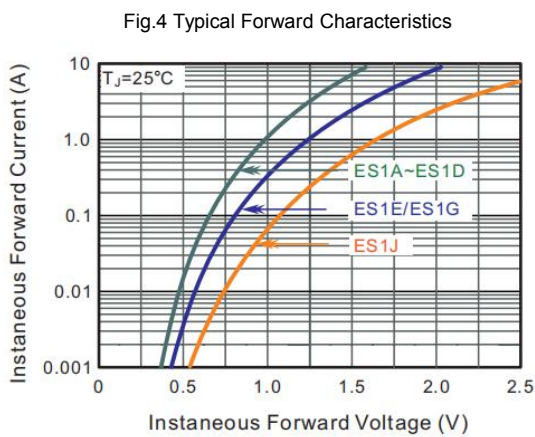
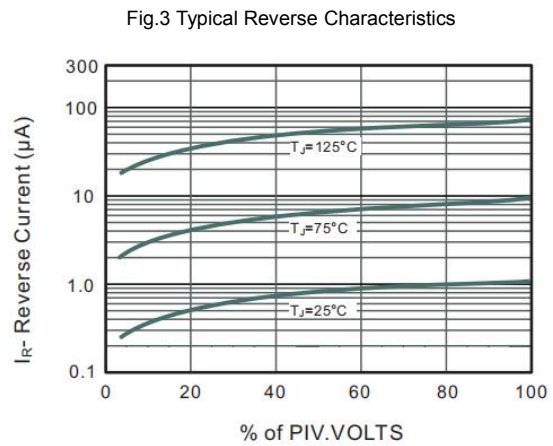
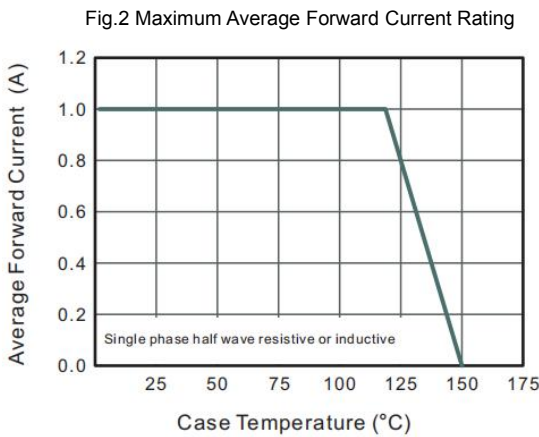
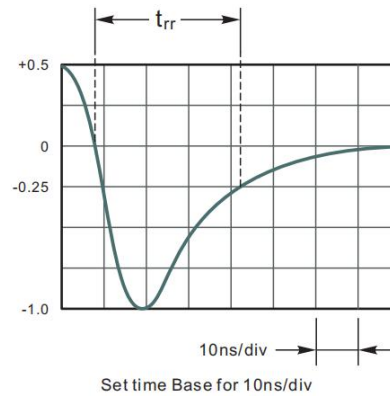
(2) P.C.B. mounted with 1.0 X 1.0" (2.54 X 2.54 cm) copper pad areas

Rating And Characteristic Curves

Fig.1 Reverse Recovery Time Characteristic And Test Circuit Diagram



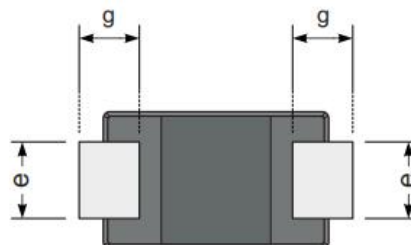
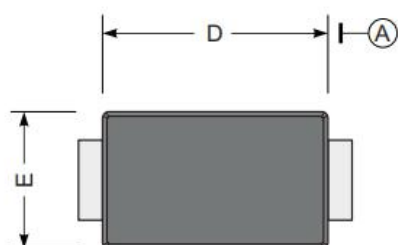
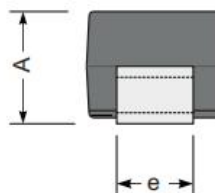
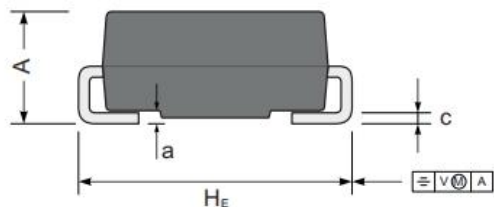
Note: 1. Rise Time = 7ns, max.
Input Impedance = 1 megohm, 22pF.
2. Rise Time = 10ns, max.
Source Impedance = 50 ohms.



Package Outline

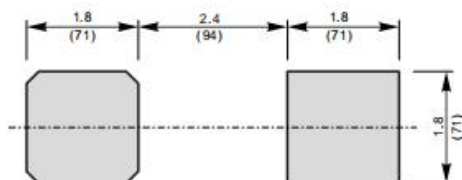
Plastic surface mounted package; 2 leads

SMA



UNIT		A	C	D	E	e	g	H _E	a
mm	max	2.2	0.31	4.5	2.7	1.6	1.5	5.2	0.3
	min	1.9	0.15	4.0	2.3	1.3	0.9	4.7	
mil	max	87	12	181	106	63	59	205	12
	min	75	6	157	91	51	35	185	

The recommended mounting pad size



Unit : $\frac{\text{mm}}{\text{mil}}$